1SS511WS

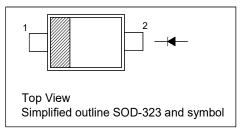
Silicon Epitaxial Planar Switching Diode

Features

- Ultra high speed switching application
- Low forward voltage
- Fast reverse recovery time
- Small total capacitance

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Absolute Maximum Ratings (T_a = 25 °C)

Parameter	Symbol	Value	Unit V V mA mA	
Peak Reverse Voltage	V_{RM}	85		
Reverse Voltage	V _R	80		
Average Rectified Forward Current	I _{F(AV)}	100		
Peak Forward Current	I _{FM}	300		
Surge Forward Current (10 ms)	IFSM	2	А	
Power Dissipation	P _{tot}	150	mW	
Junction Temperature	Tj	150	°C	
Storage Temperature Range	T _{stg}	- 55 to + 150	°C	

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient 1)	$R_{ heta JA}$	833	°C/W

¹⁾Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.



1SS511WS

Characteristics at T_a = 25 ∘C

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 10 \mu A$	V _{(BR)R}	80	-	V
Forward Voltage at I _F = 100 mA	V _F	-	1.2	V
Reverse Current at $V_R = 80 \text{ V}$	I _R	-	0.5	μΑ
Total Capacitance at $V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$	C _{tot}	-	4	pF
Reverse Recovery Time at I _F = 10 mA, I _{RR} = 0.1 * I _R , V_R = 6 V, R_L = 100 Ω	t _{rr}	-	4	ns



Electrical Characteristics Curves

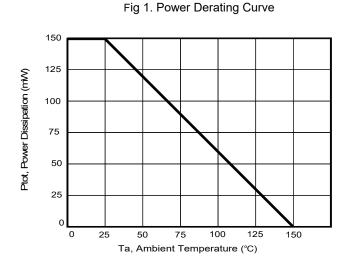


Fig 2. Total Capacitance vs. Reverse Voltage

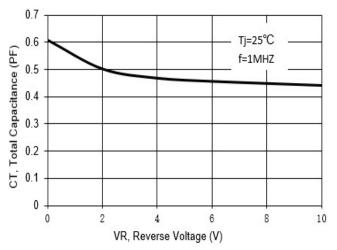


Fig 3. Reverse Current vs. Reverse Voltage

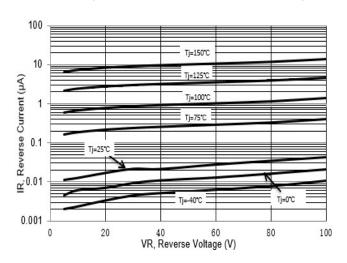
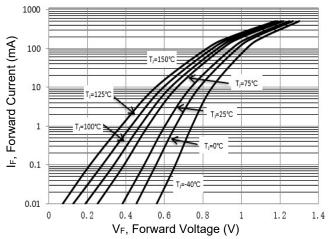


Fig 4. Forward Characteristics

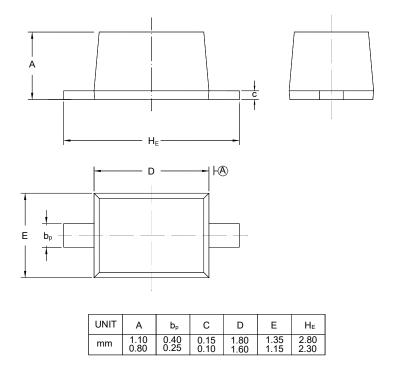




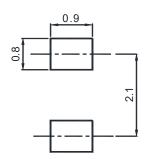
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-323



Recommended Soldering Footprint



Packing information

1 deking information						
Package	Tape Width (mm)	Pitch		Reel Size		Day Deal Deaking Quentity
		mm	(inch)	mm	(inch)	Per Reel Packing Quantity
SOD-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

" W2 " = Part No.

" III " = Cathode line

Font type: Arial



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